

# APPLIED COMPUTATIONAL ELECTROMAGNETICS SOCIETY JOURNAL

**Special Issue on Metamaterials and  
Metadevices for Integrated Sensing,  
Imaging, and Communication**

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## **Special Issue Preface**

### **Metamaterials and Metadevices for Integrated Sensing, Imaging, and Communication**

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Welcome to the special issue of the Journal of the Applied Computational Electromagnetics Society (ACES). The papers included here are related to metamaterials and metadevices for integrated sensing, imaging, and communication for 5G/6G applications.

This special issue discusses the methods and principles to integrate these functions in one system.